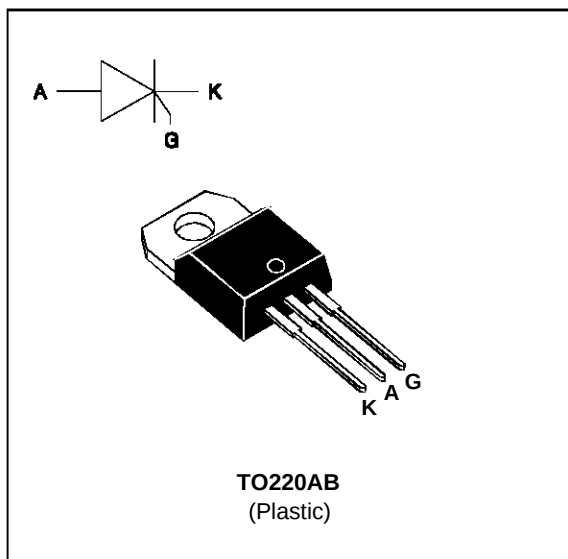


### FEATURES

- HIGH SURGE CAPABILITY
- HIGH ON-STATE CURRENT
- HIGH STABILITY AND RELIABILITY
- TXN Serie :  
INSULATED VOLTAGE = 2500V<sub>(RMS)</sub>  
(UL RECOGNIZED : E81734)

### DESCRIPTION

The TYN/TXN 0512 ---> TYN/TXN 1012 Family of Silicon Controlled Rectifiers uses a high performance glass passivated technology. This general purpose Family of Silicon Controlled Rectifiers is designed for power supplies up to 400Hz on resistive or inductive load.



### ABSOLUTE RATINGS (limiting values)

| Symbol             | Parameter                                                                                          |            |                                        | Value                          | Unit                       |
|--------------------|----------------------------------------------------------------------------------------------------|------------|----------------------------------------|--------------------------------|----------------------------|
| $I_T(RMS)$         | RMS on-state current<br>(180° conduction angle)                                                    | TXN<br>TYN | $T_c=80^{\circ}C$<br>$T_c=90^{\circ}C$ | 12                             | A                          |
| $I_T(AV)$          | Average on-state current<br>(180° conduction angle, single phase circuit)                          | TXN<br>TYN | $T_c=80^{\circ}C$<br>$T_c=90^{\circ}C$ | 8                              | A                          |
| $I_{TSM}$          | Non repetitive surge peak on-state current<br>( $T_j$ initial = $25^{\circ}C$ )                    |            | $t_p=8.3$ ms                           | 125                            | A                          |
|                    |                                                                                                    |            | $t_p=10$ ms                            | 120                            |                            |
| $I_2t$             | $I_2t$ value                                                                                       |            | $t_p=10$ ms                            | 72                             | A <sup>2</sup> s           |
| $di/dt$            | Critical rate of rise of on-state current<br>Gate supply : $I_G = 100$ mA $di_G/dt = 1$ A/ $\mu$ s |            |                                        | 100                            | A/ $\mu$ s                 |
| $T_{stg}$<br>$T_j$ | Storage and operating junction temperature range                                                   |            |                                        | - 40 to + 150<br>- 40 to + 125 | $^{\circ}C$<br>$^{\circ}C$ |
| $T_l$              | Maximum lead temperature for soldering during 10 s at 4.5 mm from case                             |            |                                        | 260                            | $^{\circ}C$                |

| Symbol                 | Parameter                                                 | TYN/TXN |     |     |     |     |     |      | Unit |
|------------------------|-----------------------------------------------------------|---------|-----|-----|-----|-----|-----|------|------|
|                        |                                                           | 0512    | 112 | 212 | 412 | 612 | 812 | 1012 |      |
| $V_{DRM}$<br>$V_{RRM}$ | Repetitive peak off-state voltage<br>$T_j = 125^{\circ}C$ | 50      | 100 | 200 | 400 | 600 | 800 | 1000 | V    |

## THERMAL RESISTANCES

| Symbol       | Parameter               |     | Value | Unit |
|--------------|-------------------------|-----|-------|------|
| Rth (j-a)    | Junction to ambient     |     | 60    | °C/W |
| Rth (j-c) DC | Junction to case for DC | TXN | 3.5   | °C/W |
|              |                         | TYN | 2.5   |      |

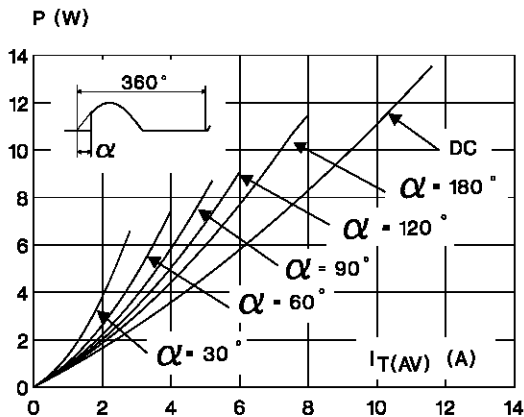
## GATE CHARACTERISTICS (maximum values)

$P_G$  (AV) = 1W     $P_{GM}$  = 10W (tp = 20  $\mu$ s)     $I_{FGM}$  = 4A (tp = 20  $\mu$ s)     $V_{RGM}$  = 5 V.

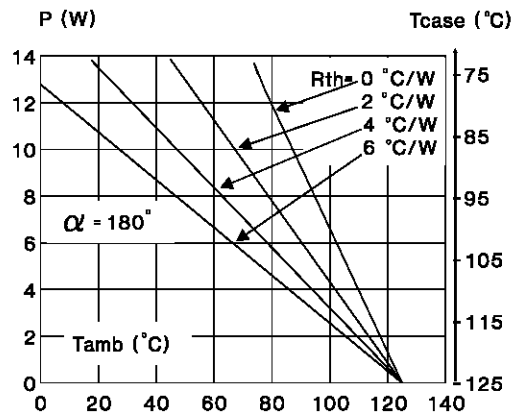
## ELECTRICAL CHARACTERISTICS

| Symbol                 | Test Conditions                                                                         |                   |     | Value | Unit       |
|------------------------|-----------------------------------------------------------------------------------------|-------------------|-----|-------|------------|
| $I_{GT}$               | $V_D=12V$ (DC) $R_L=33\Omega$                                                           | $T_j=25^\circ C$  | MAX | 15    | mA         |
| $V_{GT}$               | $V_D=12V$ (DC) $R_L=33\Omega$                                                           | $T_j=25^\circ C$  | MAX | 1.5   | V          |
| $V_{GD}$               | $V_D=V_{DRM}$ $R_L=3.3k\Omega$                                                          | $T_j=125^\circ C$ | MIN | 0.2   | V          |
| tgt                    | $V_D=V_{DRM}$ $I_G=40mA$<br>$dI_G/dt=0.5A/\mu s$                                        | $T_j=25^\circ C$  | TYP | 2     | $\mu s$    |
| $I_L$                  | $I_G=1.2 I_{GT}$                                                                        | $T_j=25^\circ C$  | TYP | 50    | mA         |
| $I_H$                  | $I_T=100mA$ gate open                                                                   | $T_j=25^\circ C$  | MAX | 30    | mA         |
| $V_{TM}$               | $I_{TM}=24A$ tp= 380 $\mu s$                                                            | $T_j=25^\circ C$  | MAX | 1.6   | V          |
| $I_{DRM}$<br>$I_{RRM}$ | $V_{DRM}$ Rated<br>$V_{RRM}$ Rated                                                      | $T_j=25^\circ C$  | MAX | 0.01  | mA         |
|                        |                                                                                         | $T_j=125^\circ C$ |     | 3     |            |
| dV/dt                  | Linear slope up to $V_D=67\%V_{DRM}$<br>gate open                                       | $T_j=125^\circ C$ | MIN | 200   | V/ $\mu s$ |
| tq                     | $V_D=67\%V_{DRM}$ $I_{TM}=24A$ $V_R=25V$<br>$dI_{TM}/dt=30 A/\mu s$ $dV_D/dt=50V/\mu s$ | $T_j=125^\circ C$ | TYP | 70    | $\mu s$    |

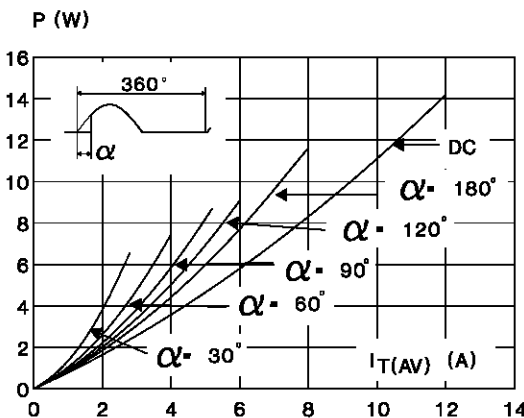
**Fig.1** : Maximum average power dissipation versus average on-state current (TXN).



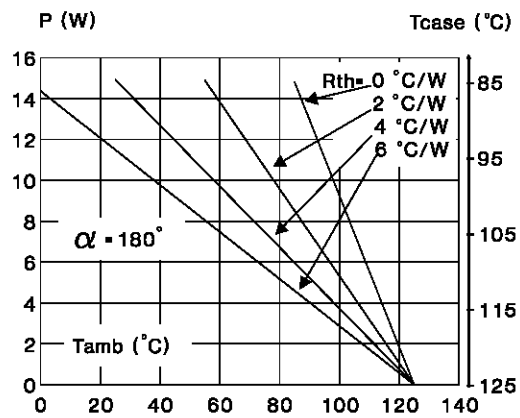
**Fig.2** : Correlation between maximum average power dissipation and maximum allowable temperatures ( $T_{amb}$  and  $T_{case}$ ) for different thermal resistances heatsink + contact (TXN).



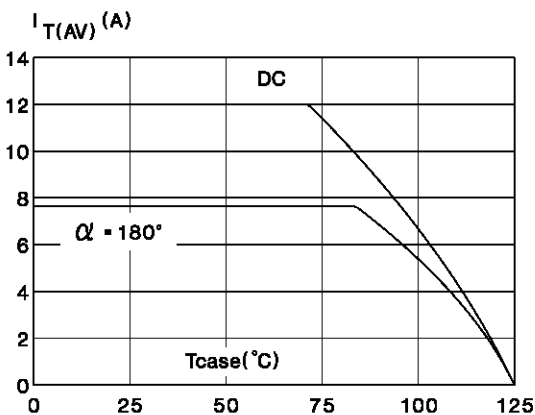
**Fig.3** : Maximum average power dissipation versus average on-state current (TYN).



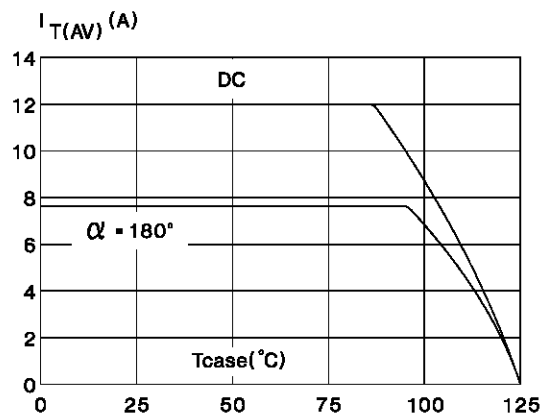
**Fig.4** : Correlation between maximum average power dissipation and maximum allowable temperatures ( $T_{amb}$  and  $T_{case}$ ) for different thermal resistances heatsink + contact (TYN).



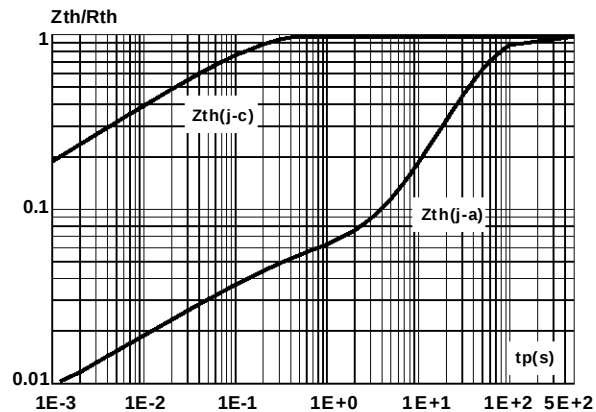
**Fig.5** : Average on-state current versus case temperature (TXN).



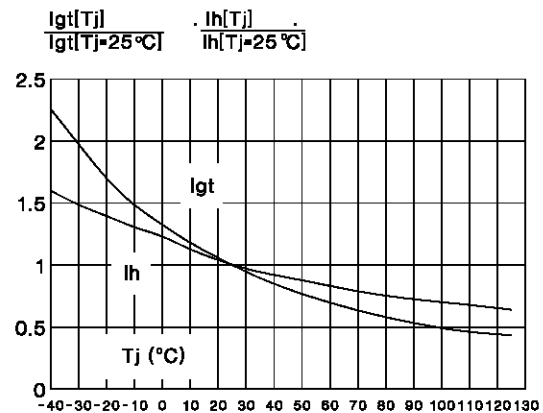
**Fig.6** : Average on-state current versus case temperature (TYN).



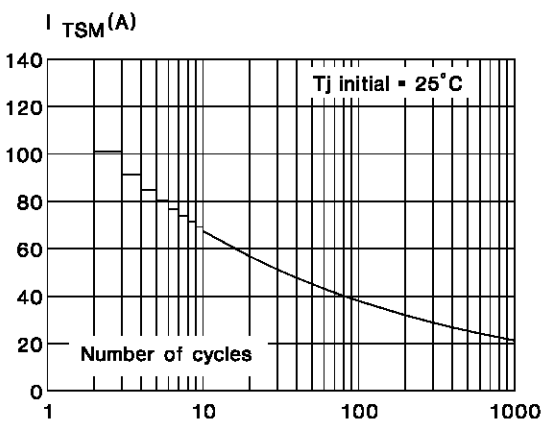
**Fig.7** : Relative variation of thermal impedance versus pulse duration.



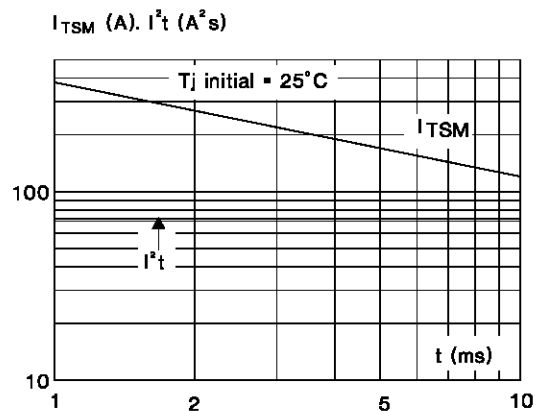
**Fig.8** : Relative variation of gate trigger current versus junction temperature.



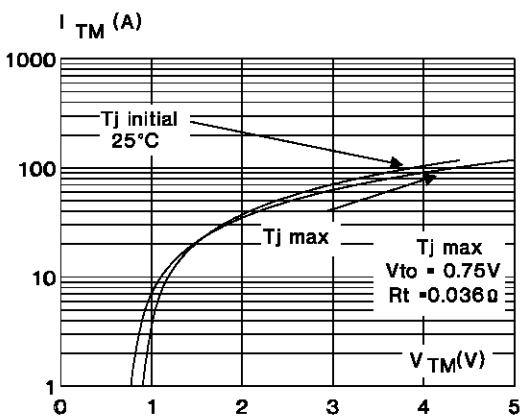
**Fig.9** : Non repetitive surge peak on-state current versus number of cycles.



**Fig.10** : Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t \leq 10$  ms, and corresponding value of  $I^2t$ .

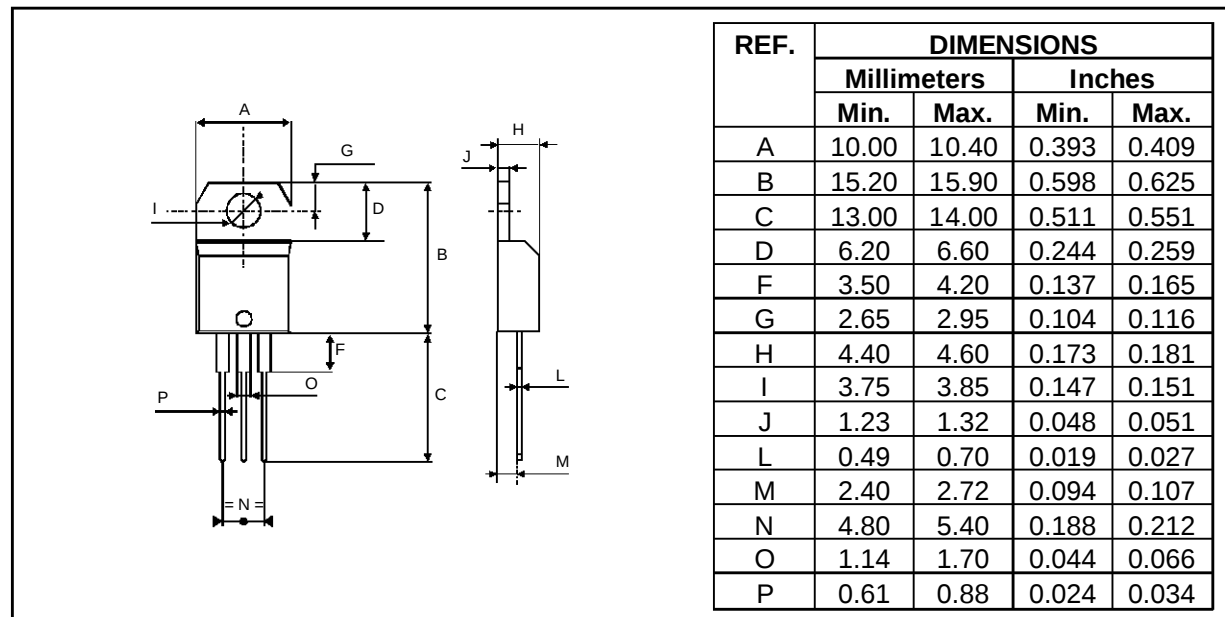


**Fig.11** : On-state characteristics (maximum values).



**PACKAGE MECHANICAL DATA**

TO220AB Plastic



Cooling method : by conduction (method C)

Marking : type number

Weight : 2.3 g

Recommended torque value : 0.8 m.N.

Maximum torque value : 1 m.N.

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